



合肥工业大学 学生成绩单

Hefei University of Technology Academic Transcript

Student ID: 2018215843 Name: Ye Bochen Gender: Male Date of Birth: September 28, 2000 Date of enrollment: September 1, 2018
 Department: School of Microelectronics Major: Integrated Circuit Design and Integrated System Length of schooling: Four years

Course	Result	Credit	Grade Point	Course	Result	Credit	Grade Point
1st Term, Academic Year 2018-2019				Signals and Systems	78	3	3.0
C/C++ Program Design	79	3	3.0	Situation and Policies (4)	99	0.25	4.3
College Physical Education 1	80	0.75	3.0	Comprehensive Training II: Analog Mixed-signal IC Design	C	1	2.0
College English (1)	exemption	2.5	3.0	Academic Writing using LaTeX	A	1	3.9
College English (2)	76	3	2.7	Creative thinking and innovative methods	97	1.5	4.3
Advanced Mathematics A (I)	75*	6	2.7	Reading and Writing of English Scientific Literature: Getting Started	87	1	3.7
Public Welfare Activities A (I)	A	0	3.9	The History of Chinese Architecture	96	1.5	4.3
Introduction to integrated circuit design and integrated system	B	0.5	3.0	GPA of This Term: 3.31		29.5	54.9
Military Theory	84	1.5	3.3	GPA of This Academic Year: 3.15		61.5	113.0
Military Training	75	2	2.7	-----Note-----			
Discrete Mathematics	80	2.5	3.0	The score without any signal mark is the score earned from the first examination; the score with the "*" is the score of retaking course; the score with the "#" is the score earned from the make-up examination.			
Enrollment Education	67	0	1.7	1st Term, Academic Year 2020-2021			
Moral Culture and Law Basis	68	3	2.0	Introduction to SoC design	86	3	3.7
Situation and Policies (1)	89	0.25	3.7	VLSI simulation and synthesis	71	3	2.0
GPA of This Term: 2.77		25.0	37.7	Volunteer Activity (Anterior Volume)	B	0	3.0
2nd Term, Academic Year 2018-2019				Mixed-signal integrated circuit design	87	2	3.7
College Students' Mental Health	68	1.5	2.0	Introduction to Mao Zedong Thoughts and Socialism with Chinese Characteristics (Front Volume)	81	3	3.0
College Physical Education 2	88	0.75	3.7	Analysis and Design of Digital Integrated Circuit	79	3	3.0
College Physics B (1)	76*	3	2.7	Digital signal processing and implementation	79	3.5	3.0
College English (3)	66	3	1.7	Situation and Policies (5)	99	0.25	4.3
Basis of Circuit Analysis	75	4	2.7	Introduction to The Communist Manifesto	99	1.5	4.3
Advanced Mathematics A (II)	83	6	3.3	Revolutionary Classic Film and Modern China Development	98	1	4.3
Public Welfare Activities A (II)	A	0	3.9	Brief Introduction of European Civilization	98	1.5	4.3
General Introduction to Basic Principles of Marxism	76	3	2.7	GPA of This Term: 3.28		21.8	38.6
Linear Algebra	76	2.5	2.7	2nd Term, Academic Year 2020-2021			
Situation and Policies (2)	89	0.25	3.7	Principles and Application of Sensor	86	2	3.7
Navigation for New College Students	92	1	4.0	Volunteer Activity (Posterior Volume)	B	0	3.0
TV Documentary	86	1	3.7	Design of Integrated Circuit Layout	88	2	3.7
Mechanical dynamics Foundation	A	1	3.9	Directions on Hunting for a Job	96	0.5	4.3
Microeconomics	82	1	3.3	Introduction to Mao Zedong Thoughts and Socialism with Chinese Characteristics (Posterior Volume)	89	2.5	3.7
GPA of This Term: 2.87		28.0	44.0	Basis of Radio Frequency Integrated Circuit Design	83	2	3.3
GPA of This Academic Year: 2.82		53.0	81.7	Experiment of Microprocessor Design	90	3	4.0
-----Note-----				Structure and Design of Microprocessor System	78	2	3.0
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1st Term, Academic Year 2019-2020				Comprehensive Training I: Digital IC Design	90	3	4.0
College Physical Education 3	86	0.75	3.7	Comprehensive Training III: Embedded System Design	A	1	3.9
College Physics B (II)	70	4	2.0	Intensive reading of A Brief History of Time	100	1	4.3
Physical Experiments of University	84	1	3.3	The Meaning of Science	100	1	4.3
College English (4)	77	2.5	2.7	Think Like an Economist: Information, Stimulation and Policy	100	1.5	4.3
Complex Function and Integral Transformation	80	2.5	3.0	Chinese History of Civilization I	100	1.5	4.3
Probability Theory and Mathematical Statistics	82	3	3.3	GPA of This Term: 3.84		23.3	58.1
Public Welfare Activities B (I)	C	0	2.0	GPA of This Academic Year: 3.57		45.0	96.7
Analog Electronic Circuit Design	83	1	3.3	-----Note-----			
Analog Electronic Circuit	83	4	3.3	The score without any signal mark is the score earned from the first examination; the score with the "*" is the score of retaking course; the score with the "#" is the score earned from the make-up examination.			
Digital Electronic Circuit Design	93	1	4.0	1st Term, Academic Year 2021-2022			
Digital Logic Circuits	72	4	2.3	Volunteer Activity (Anterior Volume)	B	0	3.0
Situation and Policies (3)	96	0.25	4.3	Comprehensive Practice of Integrated Circuit and System	A	16	3.9
Outline of Modern Chinese History	75	2.5	2.7	Situation and Policies (7)	97	0.25	4.3
Elementary French	83	1	3.3	Comprehensive Training IV: Digital ASIC Design	C	2	2.0
Career Planning of College Students	81	1	3.0	GPA of This Term: 3.70		18.3	13.2
Health Education	88	1	3.7	2nd Term, Academic Year 2021-2022			
Traditional Chinese Medicine and Health Life	A	1	3.9	Graduation Design	90	17	4.0
Self-recognition and Emotion Management	99	1.5	4.3	Innovative and Entrepreneurial Education	63	4	1.0
GPA of This Term: 3.00		32.0	58.1	Volunteer Activity (Posterior Volume)	B	0	3.0
2nd Term, Academic Year 2019-2020				Situation and Policies (8)	94	0.25	4.0
SystemC: A System Level Modelling Language	86	2.5	3.7	GPA of This Term: 3.44		21.3	12.0
Descriptive Language of Verilog Hardware and Realization of FPGA	79	3.5	3.0	GPA of This Academic Year: 3.56		39.5	25.2
College Physical Education 4	89	0.75	3.7	-----Note-----			
Physical Experiments of University	83	1	3.3	The score without any signal mark is the score earned from the first examination; the score with the "*" is the score of retaking course; the score with the "#" is the score earned from the make-up examination.			
Volunteer Activity B (Posterior Volume)	B	0	3.0	Turn to Next Page			
Analysis and Design of Integrated Analog Circuit	78	3	3.0	-----Note-----			
Embedded system and its application design	77	4	2.7	The score without any signal mark is the score earned from the first examination; the score with the "*" is the score of retaking course; the score with the "#" is the score earned from the make-up examination.			
Basis of Microelectronic Devices and Technology	82	2.5	3.3	Turn to Next Column			
Microcomputer Principles and Interface	86	3	3.7	-----Note-----			



教务处 (盖章)
Teaching Affairs Office



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Course	Result	Credit	Grade Point	Course	Result	Credit	Grade Point

-----Transcript Totals-----

Total Credits Obtained: 199.00
Overall GPA: 3.24 Ranking: 30/133

-----Note-----

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-----End of Transcript-----



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